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# H8/300L SLP Series

## Transition to Medium-Speed Active Mode

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### Introduction

Transition from the high-speed active mode to medium-speed active mode is performed through hardware and software processing.

### Target Device

H8/38024

### Contents

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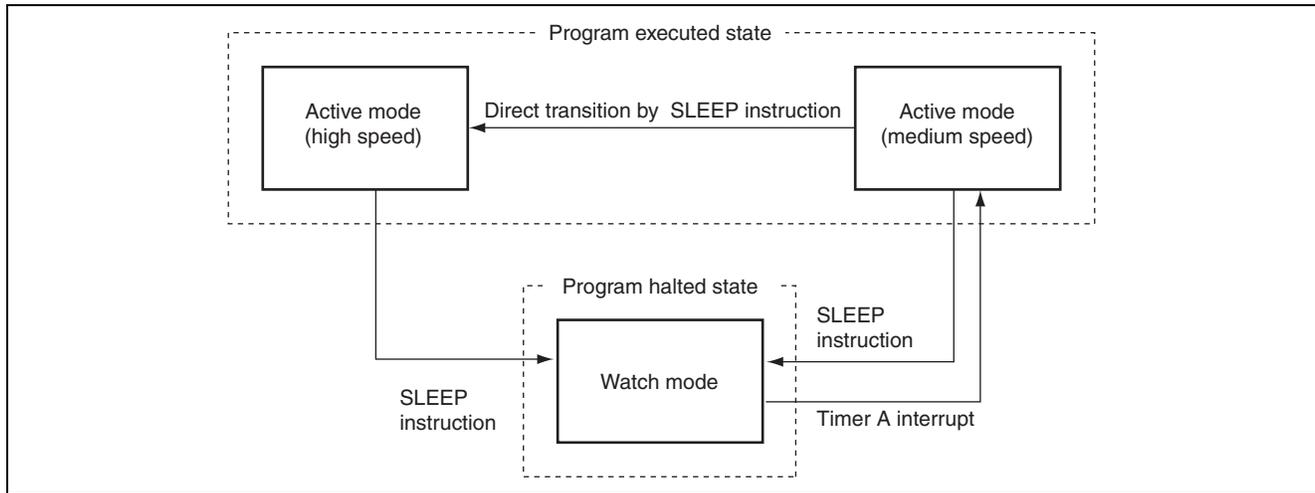
## 1. Specifications

1. This sample task shows an example of making transition to the medium-speed active mode.
2. The system enters the watch mode by executing a SLEEP instruction in the high-speed active mode.
3. The system enters the medium-speed active mode when a Timer A interrupt request is generated in the watch mode.
4. A Timer A interrupt request is generated every 0.5 sec by the clock time-base function. The LED is turned on and off in Timer A interrupt handling. After Timer A interrupt handling is completed, the operating mode again changes to the watch mode by execution of SLEEP instruction. The LED is turned on and off alternately every 0.5 sec.
5. The LED is connected to P92 output pin of port 9.
6. P92 is a large-current port.
7. A direct transition from the medium-speed active mode to the high-speed active mode takes place when the 60th Timer A interrupt request have been generated, that is, 30 sec. of time has elapsed.

## 2. Description of Functions

1. In this sample task, the operating mode is changed to the medium-speed active mode, a power down mode. Figure 2.1 shows a mode transition diagram to the medium-speed active mode. The function of the medium-speed active mode is described below.
  - The mode changes to the medium-speed active mode if LSON in SYSCR1 is 0 and MSON in SYSCR2 is 1 when an interrupt (IRQ1, IRQ0, or WKP7 to WKP0) is generated in the standby mode, an interrupt (Timer A, Timer F, Timer G, IRQ0, or WKP7 to WKP0) is generated in the watch mode, or any kind of interrupt is generated in the sleep mode (medium speed).
  - The mode does not change to the medium-speed active mode if the I bit in OCR is 1 or an acceptance of interrupts is disabled by the interrupt enable register.
  - The medium-speed active mode is terminated by a SLEEP instruction or by  $\overline{\text{RES}}$  pin input.
  - When a SLEEP instruction is executed while SSBY is set to 1 and LSON is set to 0 in SYSCR1, and TMA3 in TMA is set to 0, the medium-speed active mode is terminated and changes to the standby mode. When a SLEEP instruction is executed while SSBY in SYSCR1 is set to 1 and TMA3 in TMA is set to 1, the mode changes to the watch mode. When a SLEEP instruction is executed while SSBY is set to 0 and LSON is set to 0 in SYSCR1, the mode changes to the high-speed sleep mode if MSON in SYSCR2 is 0, or to the medium-speed sleep mode if MSON is 1. The mode changes to the high-speed active mode or to the subactive mode by direct transition.
  - In the case of terminating the mode by the  $\overline{\text{RES}}$  pin, when the  $\overline{\text{RES}}$  pin is driven "Low", the system enters a reset state and the medium-speed active mode thus ends.
  - During the medium-speed active mode, the system operates at the clock frequency set by MA1 and MA0 in SYSCR1.
  - The CPU operates in three modes to execute programs, namely, the high-speed active mode, medium-speed active mode and subactive mode. A direct transition is a transition between these three operation modes which is made without stopping the program execution. A direct transition is made by setting DTON in SYSCR2 to 1 and executing a SLEEP instruction. After a direct transition, direct transition interrupt exception handling starts. If direct transition interrupts are disabled by the interrupt enable register 2, the mode changes to the sleep mode or watch mode instead. If the direct transition is attempted while the I bit in CCR is set to 1, the mode changes to the sleep mode or watch mode, and the mode cannot be terminated by an interrupt.
  - A direct transition from the medium-speed active mode to the high-speed active mode takes place when a SLEEP instruction is executed in the medium-speed active mode while SSBY is set to 0 and LSON is set to 0 in SYSCR1, and MSON is set to 0 and DTON is set to 1 in SYSCR2. The mode changes directly from the medium-speed active mode to the high-speed active mode via the sleep mode.
  - When changing to the medium-speed active mode by terminating the watch mode by a Timer A interrupt, the waiting time for the CPU and its peripheral functions till the clock stabilizes is set by STS2 to STS0 in SYSCR1. This setting must be made so that the waiting time will be longer than 10 ms in accordance with the operating frequency.

- In this sample task the waiting time is set to 1.638 ms.
- The operating clock in the medium-speed active mode is set by MA1 and MA0 in SYSCR1. In this sample task, the operating clock in the medium-speed active mode is set to  $\phi_{osc}/128$ , which makes 78.125 kHz.



**Figure 2.1 Mode Transition to/from Medium-Speed Active Mode**

- Table 2.1 shows the assignment of functions in this sample task. Transition to the medium-speed active mode is performed by assigning the functions as shown in table 2.1.

**Table 2.1 Function Assignment**

Function	Assignment
SYSCR1	Controls power down modes.
SYSCR2	Controls power down modes.
PDR9	P92 output pin data storage
P92	LED output
TMA	Sets Timer A clock time-base function and TCA overflow period.
TCA	An 8-bit up-counter which overflows every 0.5 sec. by the clock time-base function
IRRТА	Indicates whether or not a Timer A interrupt has been requested.
IENTA	Enables or disables Timer A interrupt requests.

### 3. Principle of Operation

1. Figure 3.1 illustrates the operation of this sample task. Transition to the medium-speed active mode is made through hardware and software processing as shown in the figure.

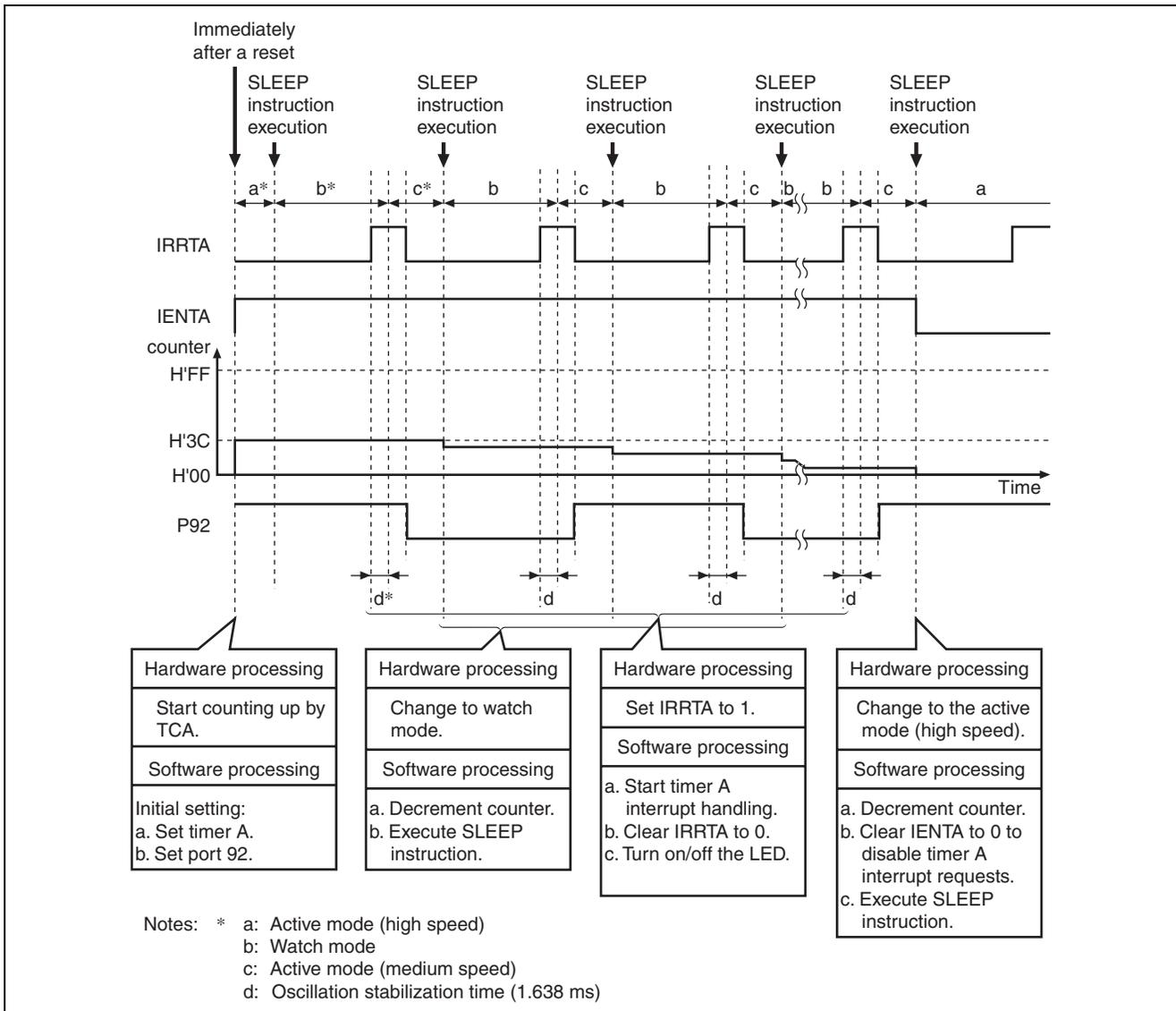


Figure 3.1 Operation Principle of Making Transition to Medium-Speed Active Mode

## 4. Description of Software

### 4.1 Modules

The modules used in this sample task are shown in table 4.1.

**Table 4.1 Description of Modules**

Module	Label	Function
Main routine	main	Makes settings for Timer A interrupts and port 9, enables interrupts, and makes transitions to the watch mode, decrements the 8-bit Timer A counter value, and disables Timer A interrupts.
LED control	taint	A Timer A interrupt handling routine which controls the LED.
Direct transition	dtint	A direct transition interrupt handling routine which clears the direct transition interrupt request flag.

### 4.2 Arguments

This sample task does not use arguments.

### 4.3 Internal Registers

Table 4.2 shows the internal registers used in this sample task.

**Table 4.2 Description of Internal Registers**

Register	Function	Address	Setting
TMA	Timer Mode Register A If TMA = H'19, Timer A function is set to the clock time-based function and TCA overflow period is set to 0.5 sec.	H'FFB0	H'19
TCA	Timer Counter A An 8-bit up counter which overflows every 0.5 sec by the clock time-base function and uses PSW output clock as input.	H'FFB1	H'00
PDR9 P92	Port Data Register 9 (Port Data Register 92) If P92 = 0, the output level on P92 pin is "Low". If P92 = 1, the output level on P92 pin is "High".	H'FFDC Bit 2	1
SYSCR1 SSBY	System Control Register 1 (Software Standby) If SSBY = 0, a transition is made to the sleep mode after a SLEEP instruction is executed in the active mode. A transition is made to the subsleep mode a SLEEP instruction is executed in the subactive mode. If SSBY = 1, a transition is made to the standby mode or watch mode after a SLEEP instruction is executed in the active mode. A transition is made to the subsleep mode after a SLEEP instruction is executed in the subactive mode.	H'FFF0 Bit 7	1
STS2	System Control Register 1 (Standby Timer Select 2, 1, 0)	H'FFF0	STS2 = 0
STS1	If STS2 = 0, STS1 = 0, and STS0 = 0, oscillation	Bit 6	STS1 = 0
STS0	stabilization time after the termination of watch mode is set to 1.638 ms.	Bit 5 Bit 4	STS0 = 0

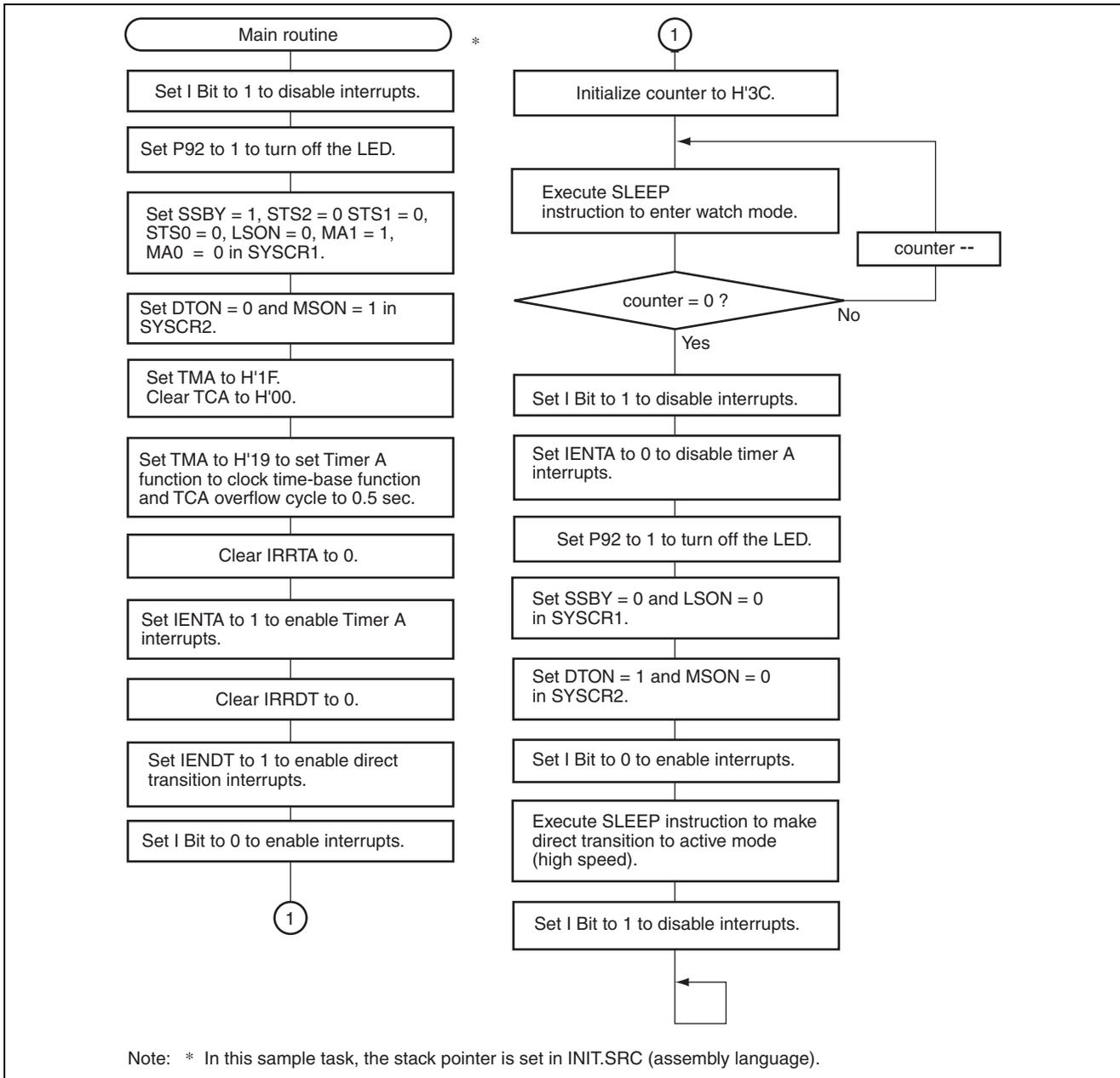
Register	Function	Address	Setting
SYSCR1	<p><b>LSON</b> System Control Register 1 (Low Speed ON Flag)</p> <p>If LSON = 0, the CPU operating clock is set to the system clock after the watch mode is terminated.</p> <p>If LSON = 1, the CPU operating clock is set to the subsystem clock after the watch mode is terminated.</p>	H'FFF0 Bit 3	0
	<p><b>MA1</b> System Control Register 1</p> <p><b>MA0</b> (Medium-speed active mode clock select 1, 0)</p> <p>If MA1 = 1 and MA0 = 1, the operating clock in the medium-speed active mode is set to <math>\phi_{OSC}/128</math>.</p>	H'FFF0 Bit 1 Bit 0	MA1 = 1 MA0 = 1
SYSCR2	<p><b>DTON</b> System Control Register 2 (Direct Transfer ON Flag)</p> <p>If DTON = 0, a transition is made to the standby, watch or sleep mode when a SLEEP instruction is executed in the active mode. a transition is made to the watch or subsleep mode when a SLEEP instruction is executed in the subactive mode.</p> <p>If DTON = 1, a direct transition is made to the high-speed active mode (if SSBY = 0, MSON = 0 and LSON = 0) or to the subactive mode (if SSBY = 1, TMA3 = 1 and LSON = 1) when a SLEEP instruction is executed in the medium-speed active mode.</p>	H'FFF1 Bit 3	0
	<p><b>MSON</b> System Control Register 2 (Medium Speed ON Flag)</p> <p>If MSON = 0, the system operates in the high-speed active mode after the standby, watch or sleep mode is terminated. The system operates in the high-speed sleep mode if a SLEEP instruction is executed in the active mode.</p> <p>If MSON = 1, the system operates in the medium-speed active mode after the standby, watch or sleep mode is terminated. The system operates in the medium-speed sleep mode if a SLEEP instruction is executed in the active mode.</p>	H'FFF1 Bit 2	0
IENR1	<p><b>IENTA</b> Interrupt Enable Register 1 (Timer A Interrupt Enable)</p> <p>If IENTA = 0, Timer A interrupt requests are disabled.</p> <p>If IENTA = 1, Timer A interrupt requests are enabled.</p>	H'FFF3 Bit 7	1
IENR2	<p><b>IENDT</b> Interrupt Enable Register 2 (Direct Transition Interrupt Enable)</p> <p>If IENDT = 0, interrupt requests by direct transition are disabled.</p> <p>If IENDT = 1, interrupt requests by direct transition are enabled.</p>	H'FFF4 Bit 7	1
IRR1	<p><b>IRRTA</b> Interrupt Request Register 1 (Timer A Interrupt Request Flag)</p> <p>If IRRTA = 0, a Timer A interrupt is not requested.</p> <p>If IRRTA = 1, a Timer A interrupt has been requested.</p>	H'FFF6 Bit 7	0
IRR2	<p><b>IRRDT</b> Interrupt Request Register 2 (Direct Transition Interrupt Request Flag)</p> <p>If IRRDT = 0, a direct transition interrupt is not requested.</p> <p>If IRRDT = 1, a direct transition interrupt has been requested.</p>	H'FFF7 Bit 7	0

#### 4.4 Description of RAM

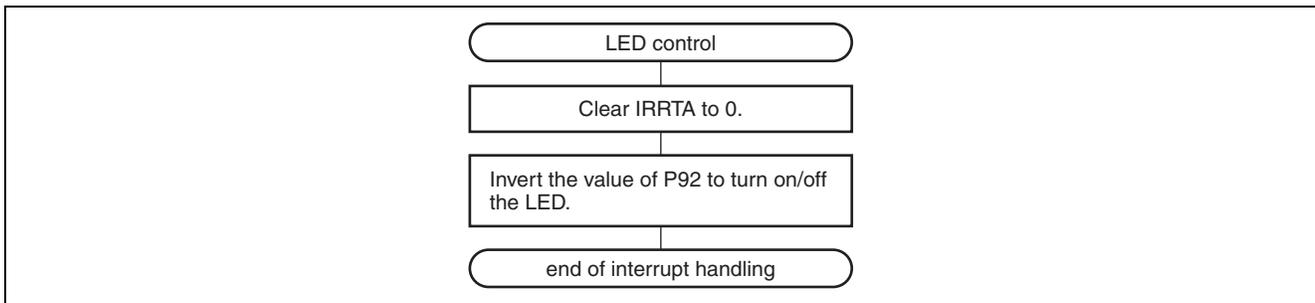
This sample task does not use RAM.

5. Flowchart

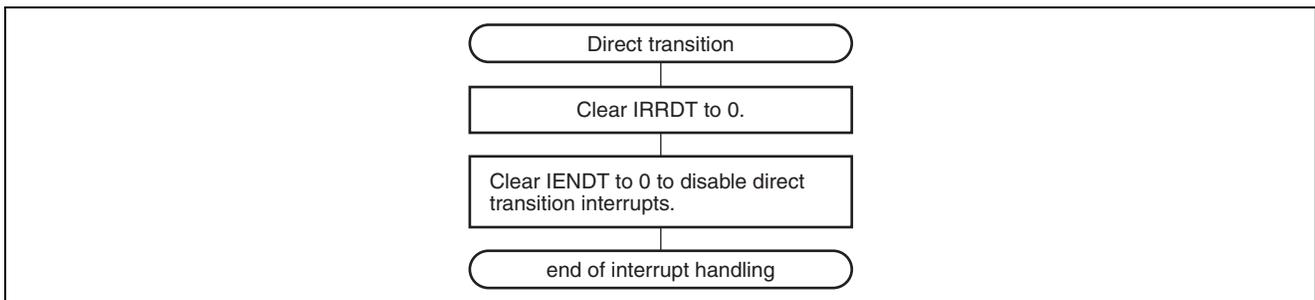
1. Main routine



### 2. Timer A interrupt handling routine



### 3. Direct transition interrupt handling routine



## 6. Program Listing

INIT.SRC (Program listing)

```

.EXPORT  _INIT
.IMPORT  _main
;
.SECTION P, CODE
_INIT:
MOV.W   #H'FF80, R7
LDC.B   #B'10000000, CCR
JMP     @_main
;
.END

/*****
/*
/* H8/300L Super Low Power Series
/* -H8/38024 Series-
/* Application Note
/*
/* 'Transition to Subactive Mode'
/*
/* Function
/* : Power-Down Mode
/* Subactive Mode
/*
/* External Clock : 10MHz
/* Internal Clock : 5MHz
/* Sub Clock      : 32.768kHz
/*
*****/

#include <machine.h>

/*****
/* Symbol Definition
*****/
struct BIT {
    unsigned char  b7:1;    /* bit7 */
    unsigned char  b6:1;    /* bit6 */
    unsigned char  b5:1;    /* bit5 */
    unsigned char  b4:1;    /* bit4 */
    unsigned char  b3:1;    /* bit3 */
    unsigned char  b2:1;    /* bit2 */
    unsigned char  b1:1;    /* bit1 */
    unsigned char  b0:1;    /* bit0 */
};

#define TMA      *(volatile unsigned char *)0xFFB0    /* Timer Mode Register A */
#define TCA      *(volatile unsigned char *)0xFFB1    /* Timer Counter A */
#define PMR2_BIT  (*(struct BIT *)0xFFC9)            /* Port Mode Register 2 */
#define IRQ0      PMR2_BIT.b0                        /* Port Mode Register 2 bit0 */
#define PDR9_BIT  (*(struct BIT *)0xFFDC)            /* Port Data Register 9 */
#define P92       PDR9_BIT.b2                        /* Port Data Register 92 */
#define PMRB_BIT  (*(struct BIT *)0xFFEE)            /* Port Mode Register B */
#define IRQ1      PMRB_BIT.b3                        /* Port Mode Register B bit3 */
#define SYSCR1    *(volatile unsigned char *)0xFFF0  /* System Control Register 1 */
#define SYSCR1_BIT (*(struct BIT *)0xFFF0)           /* System Control Register 1

```

```

#define SSBY          SYSCR1_BIT.b7          /* Software Standby          */
#define STS2          SYSCR1_BIT.b6          /* Standby Timer Select 2   */
#define STS1          SYSCR1_BIT.b5          /* Standby Timer Select 1   */
#define STS0          SYSCR1_BIT.b4          /* Standby Timer Select 0   */
#define LSON          SYSCR1_BIT.b3          /* Low Speed On Flag        */
#define MA1           SYSCR1_BIT.b1          /* Active Mode Clock Select 1 */
#define MA0           SYSCR1_BIT.b0          /* Active Mode Clock Select 0 */
#define SYSCR2        *(volatile unsigned char *)0xFFFF1 /* System Control Register 2 */
#define SYSCR2_BIT    (*(struct BIT *)0xFFFF1) /* System Control Register 2 */
#define NESEL         SYSCR2_BIT.b4          /* Noise Elimination Sampling */
/* Frequency Select          */
#define DTON          SYSCR2_BIT.b3          /* Direct Transfer On Flag   */
#define MSON          SYSCR2_BIT.b2          /* Middle Speed On Flag     */
#define SA1           SYSCR2_BIT.b1          /* Subactive Mode Clock Select 1 */
#define SA0           SYSCR2_BIT.b0          /* Subactive Mode Clock Select 0 */
#define IEGR_BIT      (*(struct BIT *)0xFFFF2) /* Interrupt Edge Select Register 1 */
#define IEG1          IEGR_BIT.b1          /* IRQ1 Edge Select         */
#define IEG0          IEGR_BIT.b0          /* IRQ0 Edge Select         */
#define IENR1_BIT     (*(struct BIT *)0xFFFF3) /* Interrupt Enable Register 1 */
#define IENTA         IENR1_BIT.b7          /* Timer A Interrupt Enable  */
#define IEN1          IENR1_BIT.b1          /* IRQ1 Interrupt Request Enable */
#define IEN0          IENR1_BIT.b0          /* IRQ0 Interrupt Request Enable */
#define IENR2_BIT     (*(struct BIT *)0xFFFF4) /* Interrupt Enable Register 1 */
#define IENDT         IENR2_BIT.b7          /* Direct Transfer Interrupt Enable */
#define IRR1_BIT      (*(struct BIT *)0xFFFF6) /* Interrupt Request Register 1 */
#define IRRTA         IRR1_BIT.b7          /* Timer A Interrupt Request Flag */
#define IRR11         IRR1_BIT.b1          /* IRQ1 Interrupt Request Flag */
#define IRR10         IRR1_BIT.b0          /* IRQ0 Interrupt Request Flag */
#define IRR2_BIT      (*(struct BIT *)0xFFFF7) /* Interrupt Request Register 1 */
#define IRRDT         IRR2_BIT.b7          /* Direct Transfer Interrupt Request Flag */

#pragma interrupt (dtint)
#pragma interrupt (irq0int)
#pragma interrupt (irq1int)
#pragma interrupt (taint)
/*****
/* Function define
*****/
extern void INIT ( void ); /* SP Set
void main ( void );
void dtint ( void );
void irq0int ( void );
void irq1int ( void );
void taint ( void );

/*****
/* RAM define
*****/
unsigned char USRF; /* User Flag Area

#define USRF_BIT (*(struct BIT *)&USRF)
#define SWONF USRF_BIT.b1 /* Switch On Flag
#define LDONF USRF_BIT.b0 /* LED On Flag

```

```

/*****
/* Vector Address
/*****
#pragma section      V1                      /* Vector Section Set          */
void (*const VEC_TBL1[])(void) = {
    INIT                      /* 0x0000 Reset Vector        */
};
#pragma section      V2                      /* Vector Section Set          */
void (*const VEC_TBL2[])(void) = {
    irq0int                   /* 0x0008 IRQ0 Interrupt Vector */
};
#pragma section      V3                      /* Vector Section Set          */
void (*const VEC_TBL3[])(void) = {
    irq1int                   /* 0x000A IRQ1 Interrupt Vector */
};
#pragma section      V4                      /* Vector Section Set          */
void (*const VEC_TBL4[])(void) = {
    taint                     /* 0x0016 timer A Interrupt Vector */
};
#pragma section      V5                      /* Vector Section Set          */
void (*const VEC_TBL5[])(void) = {
    dtint                     /* 0x0028 Sleep Interrupt Vector */
};

#pragma section                      /* P                            */
/*****
/* Main Program
/*****
void main ( void )
{
    set_imask_ccr(1);          /* Interrupt Disable          */

    LDONF = 0;                /* Initialize LDONF          */
    SWONF = 0;                /* Initialize SWONF          */

    P92 = 1;                  /* Initialize P92            */

    IRQ1 = 1;                 /* Initialize IRQ1 Terminal Input */
    IRQ0 = 1;                 /* Initialize IRQ0 Terminal Input */

    TMA = 0x1F;               /* Reset PSW & TCA          */
    TMA = 0x19;               /* Set TMA3                  */
    SYSCR1 = 0x8F;           /* Set SYSCR1                */
    SYSCR2 = 0xE0;           /* Set SYSCR2                */

    IEG0 = 0;                 /* Initialize IRQ0 Terminal Input Edge */
    IRRIO = 0;                /* Clear IRRIO              */
    IENO = 1;                 /* IRQ0 Interrupt Enable    */

    IEG1 = 0;                 /* Initialize IRQ1 Terminal Input Edge */
    IRRI1 = 0;                /* Clear IRRI1              */
    IEN1 = 0;                 /* IRQ1 Interrupt Disable   */

    IRRTA = 0;                /* Clear IRRTA              */
    IENTA = 0;                /* Timer A Interrupt Disable */

    IRRDT = 0;                /* Clear IRRDT              */
    IENDT = 1;                /* Direct Transfer Interrupt Enable */
}

```

```

set_imask_ccr(0);          /* Interrupt Enable          */
sleep();                  /* Transition to Sleep Mode  */

TMA = 0x1F;              /* Reset PSW & TCA          */
TMA = 0x19;              /* Initialize Timer A Function */

IRRТА = 0;              /* Clear IRRТА              */
IENTA = 1;              /* Timer A Interrupt Enable   */

IRRI1 = 0;              /* Clear IRRI1              */
IEN1 = 1;              /* IRQ1 Interrupt Enable     */

while(SWONF != 1){      /* SWONF = "1" ?           */
    ;
}
set_imask_ccr(1);      /* Interrupt Disable        */

P92 = 1;                /* Turn off LED             */

SYSCR1 = 0x87;          /* Set SYSCR1               */
SYSCR2 = 0xE8;          /* Set SYSCR2               */

set_imask_ccr(0);      /* Interrupt Enable        */
sleep();                /* Transition to Active Mode */
set_imask_ccr(1);      /* Interrupt Disable        */

while(1){
    ;
}

/*****
/* IRQ0 Interrupt
*****/
void irq0int ( void )
{
    IRRIO = 0;          /* Clear IRRIO              */
    IENO = 0;          /* IRQ0 Interrupt Disable   */
}

/*****
/* IRQ1 Interrupt
*****/
void irq1int ( void )
{
    IRRI1 = 0;          /* Clear IRRI1              */
    SWONF = 1;          /* Set SWONF                 */
    IENTA = 0;          /* Timer A Interrupt Disable */
    IEN1 = 0;          /* IEN1 Interrupt Disable   */
}

/*****
/* Timer A Interrupt
*****/
void taint ( void )
{
    IRRТА = 0;          /* Clear IRRТА              */

    set_imask_ccr(0);    /* Interrupt Enable        */

```

```

if(LDONF == 1){
    P92 = 1;
    LDONF = 0;
}
else{
    P92 = 0;
    LDONF = 1;
}

/*****
/* Direct Transfer Interrupt
*****/
void dtint ( void )
{
    IRRDT = 0;
    IENDT = 0;
}

```

**Link address specifications**

Section Name	Address
CV1	H'0000
CV2	H'0016
CV3	H'0028
P	H'0100

**Revision Record**

Rev.	Date	Description	
		Page	Summary
1.00	Dec.19.03	—	First edition issued

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